



FEATURES

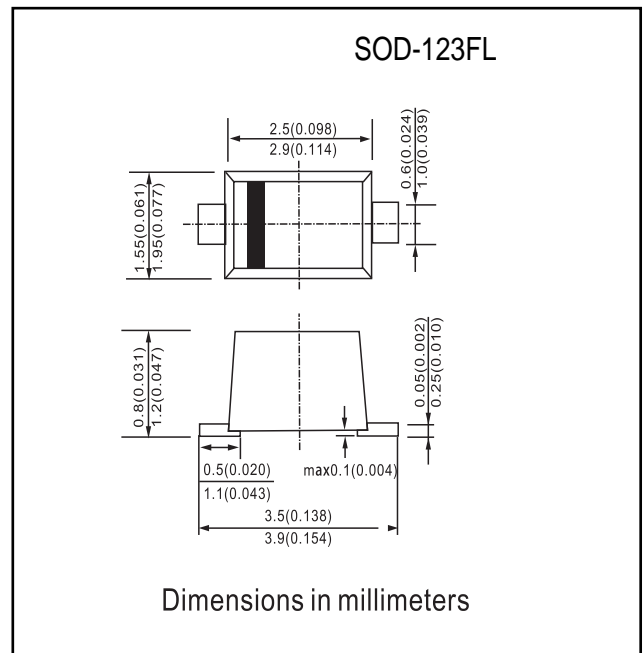
- For surface mounted applications
- Low profile package
- Ideal for automated placement
- Glass passivated
- High temperature soldering:  
260 °C/ 10 seconds at terminals
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC

MECHANICAL DATA

Case: JEDEC DO-219AB (SMF<sup>®</sup>) Plastic case

Polarity: Band denotes cathode end

Weight: approx. 15 mg



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings

T<sub>amb</sub> = 25 °C, unless otherwise specified

Parameter	Test condition	Part	Symbol	Value	Unit
Maximum repetitive peak reverse voltage		ES07B	V <sub>RRM</sub>	100	V
		ES07D	V <sub>RRM</sub>	200	V
Maximum RMS voltage		ES07B	V <sub>RMS</sub>	70	V
		ES07D	V <sub>RMS</sub>	140	V
Maximum DC blocking voltage		ES07B	V <sub>DC</sub>	100	V
		ES07D	V <sub>DC</sub>	200	V
Maximum average forward rectified current	T <sub>tp</sub> = 105 °C		I <sub>F(AV)</sub>	1.2	A
	T <sub>A</sub> = 65 °C <sup>1)</sup>		I <sub>F(AV)</sub>	0.5	A
Peak forward surge current 8.3 ms single half sine-wave	T <sub>L</sub> = 25 °C		I <sub>FSM</sub>	30	A

1) Mounted on epoxy glass PCB with 3 x 3 mm, Cu pads (≥ 40 μm thick)

Electrical Characteristics

T<sub>amb</sub> = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Maximum instantaneous forward voltage	1.0 A <sup>3)</sup>	V <sub>F</sub>			0.98	V
Maximum DC reverse current at rated DC blocking voltage	T <sub>A</sub> = 25 °C	I <sub>R</sub>			10	μA
	T <sub>A</sub> = 100 °C	I <sub>R</sub>			50	μA
Reverse recovery time	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A, I <sub>rr</sub> = 0.25 A	t <sub>rr</sub>			25	ns
Typical capacitance	4 V, 1 MHz	C <sub>j</sub>		4		pF

2) Pulse test, 300 μs pulse with 1 % duty cycle



**RATINGS AND CHARACTERISTIC CURVES ES07B THRU ES07D**

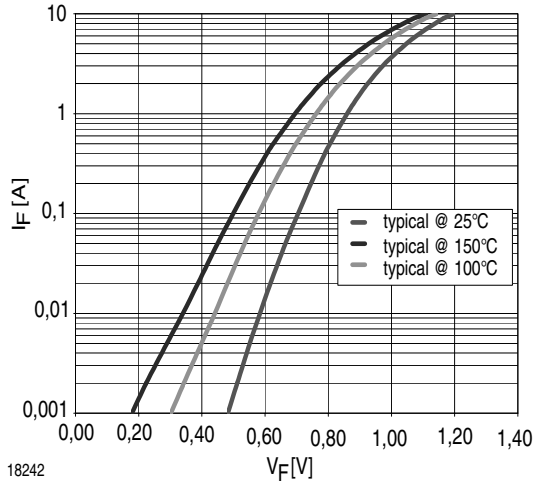


Figure 1. Typical Forward Characteristics

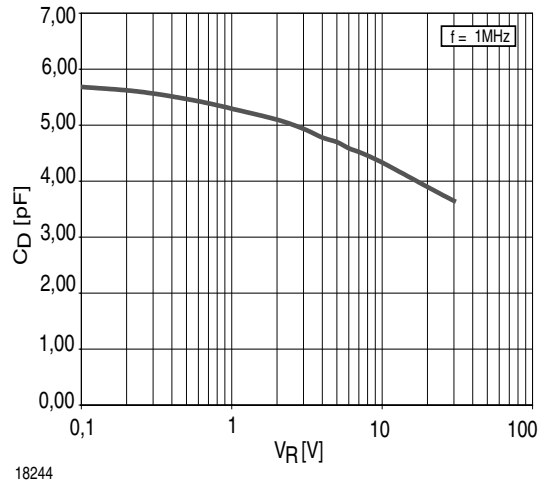


Figure 3. Typ. Diode Capacitance vs. Reverse Voltage

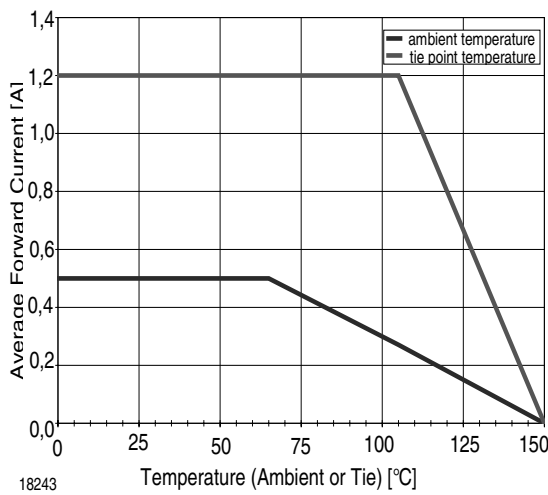


Figure 2. Forward Current Derating Curve

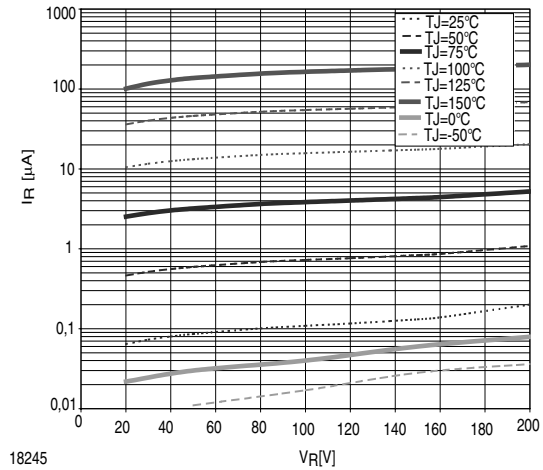


Figure 4. Typical Reverse Characteristics